

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1625	(SOI or SOG or (silicon adj insulator) or (silicon adj glass)) and (bond with (energy or strength or stress))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/14 10:48
S2	344	S1 and SOG	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/20 14:32
S3	7	S2 and (glass adj ceramic)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/20 14:32
S4	1383	(SOI or (silicon adj insulator) or (silicon adj glass)) and (bond with (energy or strength or stress))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/07/20 14:49
S5	225	S4 and (silicon with oxide with glass)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:33
S6	14040	(anodic or electrostatic) with bond\$3	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:56
S7	701	S6 and SOI	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:35
S8	552	S7 and silicon and glass	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:52

S9	0	S8 and sodium and lithium and calcium and magnesium	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:35
S10	0	S8 and sodium and lithium and calcium	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:36
S11	6	S8 and sodium and lithium	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:36
S12	2	S8 and (alkaline with earth)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:45
S13	77	S8 and (bond with strength)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:54
S14	0	S13 and joules	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:53
S15	3	S13 and Mpa	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:53
S16	991	((anodic or electrostatic) with bond\$3) and (bond with strength)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:57

S17	462	S16 and glass and (semiconductor or silicon or Si)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 18:01
S18	9	S17 and Joules	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 17:58
S19	26	S17 and (glass with silicon with strength)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	OR	ON	2005/09/13 18:02
S20	510962	thermal expansion with glass	USPAT	OR	ON	2005/09/14 10:49
S21	14419	thermala expansion with glass	USPAT	OR	ON	2005/09/14 10:48
S22	9334	(thermal adj expansion) with glass	USPAT	OR	ON	2005/09/14 10:49
S23	4417	(coefficient adj thermal adj expansion) with glass	USPAT	OR	ON	2005/09/14 10:50
S24	2083	(coefficient adj thermal adj expansion) near2 glass	USPAT	OR	ON	2005/09/14 10:50
S25	1856	S23 and silicon	USPAT	OR	ON	2005/09/14 10:50
S26	44	S25 and SOI	USPAT	OR	ON	2005/09/14 11:22
S27	4	(corning adj ("1737" or "1729" or "7740")) same resistivity	USPAT	OR	ON	2005/09/14 11:24
S28	2089	glass with resistivity	USPAT	OR	ON	2005/09/14 11:24
S29	4	(corning adj glass) with resistivity	USPAT	OR	ON	2005/09/14 11:26
S30	2089	glass with resistivity	USPAT	OR	ON	2005/09/14 11:26
S31	153	glass with resistivity with high with temperature	USPAT	OR	ON	2005/09/14 12:35
S32	1	("6048411").PN.	USPAT	OR	OFF	2006/01/29 15:31
S33	18	("4294602" "5374564" "5442205" "5559043" "5909627" "6048411" "6107653" "6140209" "6150239" "6211041" "6251754" "6309950" "6319867" "6323108" "6335231" "6391740" "6573126" "6593641").PN.	USPAT	OR	ON	2005/09/14 12:37
S34	2	("0033189" "6537938").PN.	USPAT	OR	ON	2005/09/14 12:37
S35	101	Henley.IN. and silicon	USPAT	OR	ON	2006/01/29 15:32
S36	44	S35 and implant\$5	USPAT	OR	ON	2006/01/29 15:32
S37	43	S36 and silicon\$on\$insulator	USPAT	OR	ON	2006/01/29 15:33
S38	27	S37 and (bonding with voltage)	USPAT	OR	ON	2006/01/29 15:33